# Pure, PCB



A Simpler way for PCB production.

www.purepcb.co.uk









### What can Pure do for you?

- > From 1 off Circuit upward, No MOQ/MOV
- High Mix Production Focus.
- Fast Turn & Product Prototype's.
- > UK Based inspection and Front End CAM Engineering.
- > RF & Microwave Experience.
- > Full Aerospace approved PCB supply.
- **Lean Inventory Management Systems.**
- Ease of Quoting & Ordering.





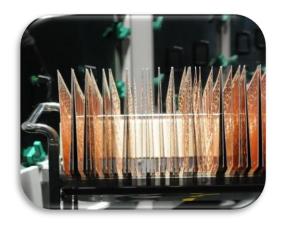
### High Mix PCB Production

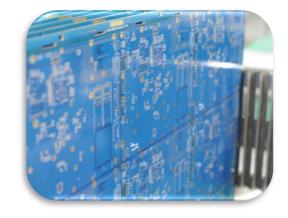
- No Minimum Order QTY or value
- STD lead time for 2/4/6, 7 Days
- HDI/BBV PCB's from 7-10 Days
- Rigid & Flex Rigid Production

- > Boards Fully BBT / Flying Probe
- First Article Inspection on all PCB's
- Micro section on all new date codes
- > Kanban & consignment stock



- 2 Days UPS from Asia
- 3 Days DHL from Asia
- Direct Shipping Available





- > ISO9000 / AS9100 Approved
- > IPC2 / IPC Class 3 Certified
- Fully UL Approved Production



### **Prototypes & Fast Turn Supply**

- > 12h Production UK
- 24 / 48 h Production (Offshore)
- 5 Day Standard Cost Production

- > 2-6 layer Count on 24 / 48h
- > BV / BBV / HDI from 3 Days Production
- Class 3 HDI from 5 Days Manufacture





Direct Shipping Available





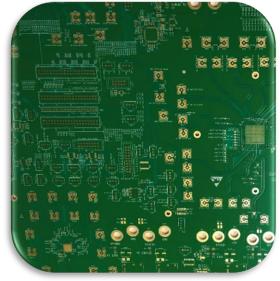
- > ISO9000 / AS9100 Approved
- > IPC2 / IPC Class 3 Certified
- > Fully UL Approved Production



## Our Rigid PCB Capability

Pure Electronics Rigid PCB Capability Overview		
РСВ	Pure PCB Current Capability	
Layer Count	1-64 Layers	
Max board Size	W ≥4mm L ≤4mm - ≤ 1200mm	
Board thickness	0.2 - 4.5mm	
Minimum Line Width & Space	3mils / 3mils	
Min. Drill Size	0.15mm	
Hole Wall Thickness	15μm - 35μm	
PTH Drill Tolerance	±0.075mm	
NPTH Drill Tolerance	±0.055mm	
Aspect Ratio	3mils / 3mils	
impedance Control Tolerance	0.1 to 3.5mm	

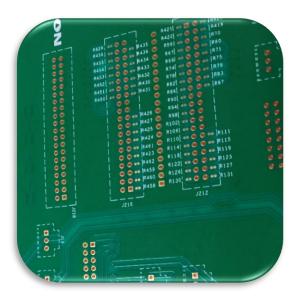


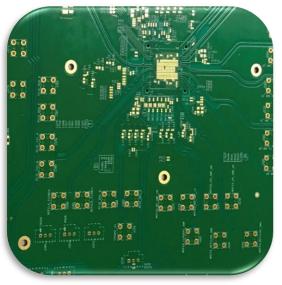




### **Our HDI PCB Capability**

Pure Electronics HDI PCB Capability Overview		
РСВ	Pure PCB Current Capability	
Layer Count	1-64 Layers	
Build-up Layer Count	W ≥4mm L ≤4mm - ≤ 1200mm	
Min. line Width / Space	0.2 - 4.5mm	
Min. Mechanical Drill Size	3mils / 3mils	
Min Laser Drill Sixe	0.15mm	
Min. Capture / Target Pad Size	15μm - 35μm	
Specialist Capability	Blind and Buried via technology, Copper filled via, stacked and staggered microvia (4 step max)	







# Our Flex Rigid PCB Capability

Pure Electronics Flex Rigid Capability Overview			
PCB Technology	Pure PCB Current Capability		
Layer Count	4 through to 28 Layer Production capability		
Available HDI Technology	1+N+1		
	2+N+2		
	3+N+3		
	4+N+4		
	Full Layer Interconnect Available		
Available PCB Thickness	0.3mm to 3.5mm		
Minimum Line Width and Space	From 0.075mm		
	ENIG		
	Lead Free HASL		
Available UDI Surface Finishes	Immersion Silver		
Available HDI Surface Finishes	Immersion Tin		
	OSP		
	ASIG/ISIG		
Suitable HDI Materials Available	Standard TG FR4		
	High TG FR4		
	Taconic/Rogers/Arlon/Nelco/Isola		
	Halogen Free FR4		
	Mechanically Drilled 0.15mm		
Minimum Available Drill Size	Laser Drilled 0.1mm		
	Aspect Ratio 1:0.8		
Via Fill Option	Resin Fill Via		
	Copper plated shut up to max 6L		
	Solder Mask Ink		





## Our Flexible PCB Capability

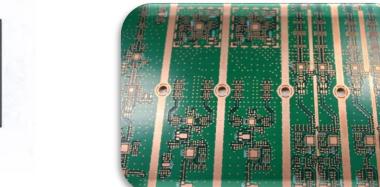
Pure Electronics RF PCB Capability Overview			
Cate	egory	Pure PCB Current Capability	
Materials	Laminate	Adhesive-Coated, Non-Adhesive coated	
	Reinforcement	PI, FR4	
	Adhesive	Acrylic	
	Coverlay	Adhesive Layer: Epoxy, Acrylic	
No. Of Layers	Flexible Board	4	
Board Thickness	Finished Board	min 0.07mm	
	Tolerance	min ±0.03mm	
Copper Thickness	Inner Layer	1/3 - 10z	
	Surface	1/3 - 20z	
Unit Size	Min.	min 20mm x 20mm	
	Max.	max 457 x 610mm	
Line Width / Line Spacing	Inner Layer	3mil / 3mil	
	Outer Layer	3mil / 3mil	
	CNC	min Ø 0.15mm	
Hole Size	Laser	min Ø 0.10mm	
Drill Aspect Ratio	Laser	max 1.2:1	
	CNC	max 15:1	
Core Thickness	Flexible Core	min 0.0125mm	
Size Tolerance	Laser Cut	± 0.05mm	
	Mould Punch	min 0.05mm	
Surface Finishing		Immersion Gold, Gold Plating, HASL,	
		OSP, immersion Tin, ENIPIG, Immersion	
		Silver, Tin / Copper Plating	



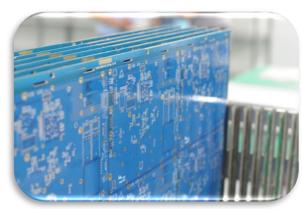


### Why Pure PCB?

- > IP Security & Control
- ) UK Held Data
- > UK / FE CAM Engineering
- **)** UK Domiciled Business
- ) ISO 9000 Approval
- Xanban & Consignment stock models
- ) ISO9001 LRQ 4009361



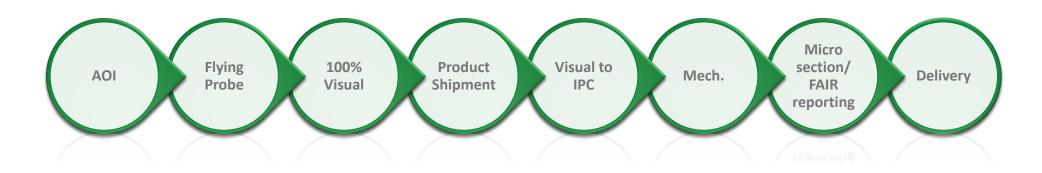








# PCB quality verification.



### **Factory Quality Verification**



### **Pure UK Product Verification**





### Securing Our PCB Production.

> Pure Electronics has a robust & secure process for assuring manufacturing & product capability.

• Ensuring ongoing capability management **Factory Audits**  Assuring ongoing financial viability & **Factory Commercial Audits** competiveness Maintaining integrity of information and Localised Management (Cebu) data in real time **UK Front End Engineering** • Pre manufacture data verification (CAM/DFM) Local UK Mechanical & Visual • Post manufacture product verification Inspection Micro Section & Fault Reliability assurance and verification Diagnosis



### Transparent Manufacturing

> Pure PCB provide a fully transparent PCB production process for all prototype and pre-production printed Circuit Boards, ensuring Customers are kept up to date.





### **Contact Us**



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